REMARKS

Favorable reconsideration of this application, as amended, is respectfully requested.

Minor errors in the specification have been corrected, without introducing new matter.

Claims 1 and 6 have been amended to distinguish patentably from Park et al. or Park et al. in view of Izumitani et al.

Claims 1 and 6 now recite that an end portion of an electrode is disposed nearer an outer periphery portion of the semiconductor chip than that of the die pad, and the die pad is not positioned under the end portion of the electrode. See, e.g., Figs. 19, 22, 27, 31, 32, and 33. By virtue of the invention, even in case of transmitting a high-frequency signal to the electrode, the transmission can be accomplished without loss. See, e.g., page 17, lines 3-5 and 10-12 of Applicants' specification.

Neither Park et al., relied upon in the rejection under 35 U.S.C. § 102(b), nor Izumitani et al., relied upon in the rejection under 35 U.S.C. § 103(a) with Park et al., teaches or suggests the inventions now recited in Claims 1 and 6, or the claims dependent thereon.

Accordingly, this application is believed to be in condition for allowance.

The Commissioner is hereby authorized to charge to Deposit Account No. 50-1165 any fees under 37 C.F.R. §§ 1.16 and 1.17 that may be required by this paper and to credit any overpayment to that Account. If any extension of time

is required in connection with the filing of this paper and has not been requested separately, such extension is hereby requested.

Respectfully submitted,

Nelson H. Shap ro Reg. No. 17,095

NHS: 1mb

Miles & Stockbridge P.C. 1751 Pinnacle Drive Suite 500 McLean, Virginia 22102 (703) 903-9000

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